



RoHS Compliant

**MAX
260°C**

**MSL
1**



PRODUCT FAMILY	Material	CAS Number	% Normalize for BOM	Wt. Of BOM Item (g)	% by Wt (Comp. Item)	mg/unit	% by Wt Of Unit 102.00	ppm
753 9 SRT	Alumina Ceramic	Al2O3	0.8800	0.0898	87.50%	78.5400	77.00%	770000
		SiO2 (silicon dioxide)			12.50%	11.2200	11.00%	110000
					100.00%	89.7600		
	Conductor Thick Film	Ag	0.0068	0.0007	100.00%	0.6936	0.68%	6800
					100.00%	0.6936		
	Resistor Thick Film	RuO2	0.0079	0.0008	30.00%	0.2417	0.24%	2370
		PbO			10.00%	0.0806	0.08%	790
		SiO2 (silicon dioxide)			30.00%	0.2417	0.24%	2370
		B2O3			30.00%	0.2417	0.24%	2370
					100.00%	0.8058		
	Notch Conductor Thick Film	Ag	0.0113	0.0012	100.00%	1.1526	1.13%	11300
					100.00%	1.1526		
	Underplate	Ni	0.0250	0.0026	100.00%	2.5500	2.50%	25000
					100.00%	2.5500		
	Finish Plate	Sn	0.0170	0.0017	100.00%	1.7340	1.70%	17000
					100.00%	1.7340		
	Covercoat	TiO2	0.0520	0.0053	50.00%	2.6520	2.60%	26000
		Silicone			50.00%	2.6520	2.60%	26000
		Sum	1.0000	0.1020	100.00%	5.3040		
			part weight	0.1020				
		Totals:		0.1020		102.00	100.00%	1000000

RoHS exemption claimed for lead in glass of electronic component